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PATENT
Docket No.: 16869P-042900US
Client Ref. No.: 210000749US1

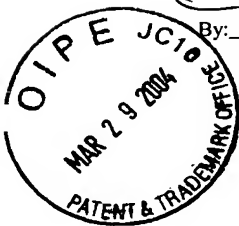
On

March 24, 2004

TOWNSEND and TOWNSEND and CREW LLP

By:

Margaret K. Steple



IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re application of:

Takenori HIROSE, et al.

Application No.: 10/081,385

Filed: February 20, 2002

For: Film Thickness Measuring Method
and Apparatus, and Thin Film Device
Manufacturing Method and Manufacturing
Apparatus Using Same

Examiner: Hwa S. Lee

Art Unit: 2877

Response to Restriction Requirement

Commissioner for Patents
P.O. Box 1450
Alexandria, VA 22313-1450

Sir:

In response to the Restriction Requirement mailed February 25, 2004, counsel for Assignee elects to prosecute the claims of Group I (claims 1-28) without traverse.

If the Examiner believes a telephone conference would expedite prosecution of this application, he is invited to telephone the undersigned at 650-326-2400.

Respectfully submitted,

Robert C. Colwell

Robert C. Colwell
Reg. No. 27,431

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